ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-American c	burn, Illinois, A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities and the declaration entities are an entities and the declaration entities are an entite are an entities are an entities are an entite are	on of the su	bstances all lower	within the manufactu r level materials for w	rer listed it which the m	tem. Note: nanufacture	if the item is an as er has engineering	sembly with lower responsibility.	
IPC Web Site for Information on IPC-1752 Standard Form			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials at					ials and M	and Mfg Information			
Supplier Information													
ompany name* Company unique ID				Unique ID Authority					Response Date*				
isemi										2024-04-30			
Contact Name	Title - Contact				Phone - Contact*				Email - Contact*				
oduct-Env-Stewards Product Enviro Compliance					NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro C			o Compliance		NA			Product-Env-Stewards@onsemi.com					
Requester Item Number Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	N	Anufacturing Site	,	Weight*	UOM	Unit Type	
MC74V 5G	HC1G125P5T Non-Inverting 3-State Buf		State Buffer		2024-04-30				-	1.18	mg	Each	
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Ferminal Base Alloy J-STD-020 N			Rating	Peak Process Body Temperature Max Time at Pea			Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30	secon	ds 3			
Comments													
evel 1 - maximum time at peak temperature during so	Idering is 10-3	0 seconds											
For more information regarding material composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg	
Lead Frame	0.52	mg	Supplier	Silver (Ag)	7440-22-4		0.0926	mg	
			В	Nickel (Ni)	7440-02-0		0.1607	mg	
			Supplier	Iron (Fe)	7439-89-6		0.222	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0447	mg	
Mold Compound-Black	0.6	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.06	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.003	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.087	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		0.39	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.06	mg	
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg	
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg	